© Copyright	Composition De 2005. IPC, Bannock and Pan-American c	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, th	ent is a declaration e	on of the su	bstances v all lower	vithin the manufactu level materials for w	rer listed iter hich the ma	n. Note: if nufacturer	f the item is an as has engineering	sembly with low responsibility.	
				Form Type Distribute	*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					ls and Mfg Information			
upplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Response Date*				
nsemi									2025-06-06					
Contact Name Title - 0			itle - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title -			itle - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iter	n Number	Mfr Item Name		·	Effective Date	e Date Version Manufacturing Site		lanufacturing Site	W	eight*	UOM	Unit Type	
	NTMJS WG			T6 40V LL LFPAK		2025-06-06		PI	PBB		.445	mg	Each	
Aanufacturing Proccess Inf	ormation													
Terminal Plating / Grid A	Terminal Plating / Grid Array Material Terminal Base A		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature		e Max Time at Peak	Temperatur	e Numb	er of Reflow Cyc	les		
Matte Tin (Sn) - annealed C		CU Alloy	Alloy 1			260	60 C 30		30	seconds 3				
omments														
vel 1 - maximum time at peak ten	nperature during so	oldering is 10-3	0 seconds											
or more information regarding m	aterial composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, admium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part ontains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall ncompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, so fithe date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the ROHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not ndependently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the ertification in this paragraph. If the Company and the Supplier remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the varrant										
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.9	mg	Supplier	Iron (Fe)	7439-89-6		0.0083	mg
			Supplier	Copper (Cu)	7440-50-8		6.8896	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0021	mg
Die	1.1	mg	Supplier	Silicon (Si)	7440-21-3		1.1	mg
Lead Frame	36.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0037	mg
			Supplier	Iron (Fe)	7439-89-6		0.044	mg
			Supplier	Copper (Cu)	7440-50-8		36.6413	mg
			Supplier	Phosphorus (P)	7723-14-0		0.011	mg
Mold Compound-Black	41.4	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.207	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		6.21	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.21	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1035	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		26.3925	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.277	mg
lating	6.3	mg	Supplier	Tin (Sn)	7440-31-5		6.3	mg
Solder Paste	7.0	mg	Supplier	Silver (Ag)	7440-22-4		0.175	mg
			А	Lead (Pb)	7439-92-1	7a	6.475	mg
			Supplier	Tin (Sn)	7440-31-5		0.35	mg
Wire Bond - Cu	0.045	mg	Supplier	Copper (Cu)	7440-50-8		0.045	mg